These assemblies are ESD sensitive. ESD precautions shall be observed.

These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

Heat Sink is mounted on Top Layer
You should completely validate and test your design implementation to confirm the system functionality for your application.

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